

LISTING OF CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the application:

1. (Currently amended) An organic light emitting device ~~(1)~~, ~~in particular an OLED~~, comprising: ~~at least~~
a first glass substrate ~~(12)~~;
an organic light emitting layer arrangement ~~(20)~~, wherein
the organic light emitting layer arrangement which comprises a
first and second electrode ~~(22, 26)~~ and an organic
electroluminescent layer ~~(24)~~; and
an encapsulation ~~(14, 28)~~, encapsulating by means of which
the organic light emitting layer arrangement (20) is
encapsulated, wherein the first glass substrate, the organic
light emitting layer arrangement and the encapsulation forming a
light emitting composite element ~~(10)~~; and
characterized by
a functional layer ~~(34)~~ applied on the light emitting
composite element ~~(10)~~, wherein the functional layer is formed
as an antishatter protective layer, and wherein at least the
first glass substrate and the antishatter protective layer form
a composite element.

2. (Cancelled)

3. (Currently amended) The device ~~(1)~~ as claimed in claim
one of the preceding claims, wherein the encapsulation ~~(14, 28)~~
comprises an adhesively bonded on a second substrate adhesively
bonded on the first glass substrate or the organic light
emitting arrangement (14).

4. (Currently amended) The device ~~(1)~~ as claimed in claim 3 one of the preceding claims, further comprising wherein a third substrate ~~(38)~~ is applied on the functional layer ~~(34)~~, so that the functional layer ~~(34)~~ is arranged between the first and third substrates ~~(12, 38)~~, and wherein at least the first and third substrates ~~(12, 38)~~ and the antishatter protective layer ~~(34)~~ form a the composite element ~~(30)~~.

5. (Currently amended) The device ~~(1)~~ as claimed in claim 1 one of the preceding claims, wherein the functional layer ~~(34)~~ comprises first and second sections ~~(46, 44)~~, wherein the first sections ~~(46)~~ is essentially being light-transmissive and the second sections ~~(44)~~ is essentially light-opaque.

6. (Currently amended) The device ~~(1)~~ as claimed in claim 1 one of the preceding claims, wherein the functional layer ~~(34)~~ is formed as a multicolor patterned mask.

7. (Currently amended) The device ~~(1)~~ as claimed in claim 1 one of the preceding claims, wherein the functional layer ~~(34)~~ comprises a plastic layer.

8. (Currently amended) The device ~~(1)~~ as claimed in claim 1 one of the preceding claims, wherein the functional layer ~~(34)~~ comprises a plastic film.

9. (Currently amended) The device ~~(1)~~ as claimed in claim 1 one of the preceding claims, wherein the functional layer ~~(34)~~ is adhesively bonded on the light emitting composite element~~on~~.

10. (Currently amended) The device ~~(1)~~ as claimed in claim
~~1 one of the preceding claims~~, wherein the functional layer ~~(34)~~
comprises a self-adhesive film.

11. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first and third
substrates ~~(12, 38)~~ and the antishatter protective layer ~~(34)~~
are adhesively bonded in areal fashion to form [[a]] the
composite element ~~(30)~~.

12. (Currently amended) The device ~~(1)~~ as claimed in claim
~~1 one of the preceding claims~~, wherein the functional layer ~~(34)~~
is adhesively bonded on the light emitting composite element by
means of a crosslinking adhesive ~~(32)~~.

13. (Currently amended) The device ~~(1)~~ as claimed in claim
~~1 one of the preceding claims~~, wherein the functional layer ~~(34)~~
comprises a printed-on layer.

14. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first, second and/or
third substrate ~~(12, 14, 38)~~ comprise a glass substrate.

15. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first, second and/or
third substrate ~~(12, 14, 38)~~ comprise hardened glass.

16. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first, second and/or
third substrate ~~(12, 14, 38)~~ comprise a glass-plastic composite.

17. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first, second and/or
third substrate ~~(12, 14, 38)~~ comprise a plastic-coated glass or
a laminated glass-plastic composite.

18. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the third substrate ~~(38)~~
~~is provided with~~ has an antireflection coating ~~(48)~~.

19. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the end sides ~~(6, 8)~~ of
the first, second and/or third substrate ~~(12, 14, 38)~~ and/or of
the functional layer has opposing end sides ~~(34)~~ are
~~postprocessed after adhesive bonding~~.

20. (Currently amended) The device ~~(1)~~ as claimed in claim
~~1 one of the preceding claims~~, wherein at least one end side ~~(6,~~
~~8)~~ of the organic light emitting device ~~(1)~~ has at least one end
side that is beveled.

21. (Currently amended) The device ~~(1)~~ as claimed in claim
~~4 one of the preceding claims~~, wherein the first, second and/or
third substrate ~~(12, 14, 38)~~ hasve a thickness of 10 μm to 2000
 μm .

22. (Currently amended) The device ~~(1)~~ as claimed in claim
1 one of the preceding claims, wherein the first and second
substrate ~~(12, 14)~~ are adhesively bonded to one another by ~~means~~
of a first adhesive layer ~~(28)~~, wherein the first substrate ~~(12)~~
and the functional layer ~~(34)~~ are adhesively bonded to one
another by ~~means of~~ a second adhesive layer ~~(32)~~, and wherein
the functional layer ~~(34)~~ and the third substrate ~~(38)~~ are
adhesively bonded to one another by ~~means of~~ a third adhesive
layer ~~(36)~~.

23. (Currently amended) The device ~~(1)~~ as claimed in claim
22, wherein the first, second and third adhesive layers ~~(28, 32,~~
~~36)~~ each have a thickness of 3 μm to 100 μm .

24. (Currently amended) The device ~~(1)~~ as claimed in claim
1 one of the preceding claims, wherein the organic light
emitting device ~~it~~ has a thickness of 150 μm to 10 mm.

25. (Currently amended) The device ~~(1)~~ as claimed in claim
1 one of the preceding claims, wherein it further comprising
comprises an energy source ~~(54)~~ and a switch ~~(58)~~ for switching
the organic light emitting device ~~(1)~~ on and off.

26. (Currently amended) The device ~~(1)~~ as claimed in claim
3 one of the preceding claims, wherein the second substrate ~~(14)~~
defines a rear side ~~(4)~~ of the organic light emitting device,
and wherein a dielectric housing ~~(52)~~ is fitted to the rear side
~~(4)~~, and wherein the dielectric ~~which~~ housing has is arranged an
energy source ~~(54)~~.

27. (Currently amended) The device ~~(1)~~ as claimed in claim
~~25 one of the preceding claims, further comprising characterized~~
by a holding clip that interacts with the switch in such a way
that the switch is actuated by the holding clip (58).

28. (Cancelled)

29. (Currently amended) The device ~~(1)~~ as claimed in claim
~~27 or 28, wherein the switch (56) is integrated in the holding~~
clip ~~(58).~~

30. (Currently amended) The ~~use of the organic light~~
emitting device ~~(1)~~ as claimed in claim 1, wherein the organic
light emitting device is adapted for use ~~one of the preceding~~
~~claims as a self-luminous, in particular patterned information~~
~~sign or as a self-luminous, in particular patterned~~
information area.

31. (Currently amended) A method for producing an organic
light emitting device ~~(1) in particular as claimed in one of the~~
~~preceding claims, comprising:~~

providing an organic light emitting composite element ~~(10)~~
~~being provided, wherein the organic light emitting composite~~
~~element which comprises at least a first glass substrate (12),~~
~~an encapsulation (14, 28) and an organic light emitting layer~~
~~arrangement; (20),~~

encapsulating the organic light emitting layer arrangement
~~(20) being encapsulated by means of the first glass substrate~~
~~(12) and the encapsulation, (14, 28) and wherein the organic~~
~~light emitting layer arrangement comprises comprising at least a~~
~~first and second electrode (22, 26) and an organic~~
~~electroluminescent layer (24), wherein;~~

applying a functional layer (34) is applied to the organic light emitting device (1), wherein the functional layer is an antishatter protective layer; and

producing a composite element comprising the first glass substrate and the antishatter protective layer.

32. (Currently amended) The method as claimed in claim 31, wherein the applying step further comprises applying the functional layer to
~~during operation, at a front side of the organic light emitting device, light (42) emerges from the organic light emitting device (1) and the functional layer (34) is applied to the front side of the organic light emitting device (1).~~

33. (Currently amended) The method as claimed in claim 31
~~or 32, further comprising applying wherein~~ a third substrate (38) is applied to the functional layer (34).

34. (New) The device as claimed in claim 19, wherein the opposing end sides are postprocessed after the second substrate is adhesively bonded to the first glass substrate or the organic light emitting arrangement.